### SMALL SMD HIGH - FREQUENCY CRYSTAL UNIT

# **MA-306**

- High-density mounting-type SMD.
- Excellent reliability and environment capability.
- Capable of covering a wide frequency range. (from 17.734 MHz to 41 MHz)

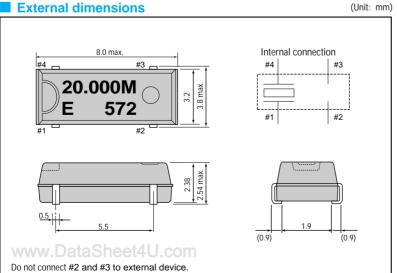


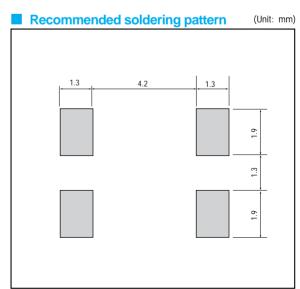
#### ■ Specifications (characteristics)

| Item                                             |                         | Symbol         | Specifications                                                   | Remarks                                                                                                     |
|--------------------------------------------------|-------------------------|----------------|------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------|
| Nominal frequency                                |                         | f              | 17.734 MHz to 41.000 MHz                                         | Fundamental mode                                                                                            |
| Temperature range                                | Storage temperature     | Тѕтс           | -55°C to +100°C                                                  | Stored as bare product after unpacking                                                                      |
|                                                  | Operating temperature   | Topr           | -20°C to +70°C                                                   |                                                                                                             |
| Drive level                                      | Maximum drive level     | GL             | 2mW max.                                                         | Only crystal oscillation is guaranteed                                                                      |
|                                                  | Recommended drive level | DL             | 10μW to 100μW                                                    |                                                                                                             |
| Soldering condition                              |                         | Tsol           | Twice at under 260°C within 10 sec. or under 230°C within 3 min. |                                                                                                             |
| Frequency tolerance (standard)                   |                         | Δf/f           | ±50ppm                                                           | Ta=25°C±3°C                                                                                                 |
| Frequency temperature characteristics (standard) |                         |                | ±30ppm                                                           | -20°C to +70°C                                                                                              |
| Load capacitance                                 |                         | CL             | 10pF to ∞                                                        | Please specify                                                                                              |
| Series resistance                                |                         | R <sub>1</sub> | 60 Ω max.                                                        | -20°C to +70°C, DL=100μW                                                                                    |
| Shunt capacitance                                |                         | Co             | 5pF max.                                                         |                                                                                                             |
| Insulation resistance                            |                         | IR             | 500 MΩ min.                                                      |                                                                                                             |
| Aging                                            |                         | fa             | ±5ppm/year max.                                                  | Ta=25°C±3°C, first year                                                                                     |
| Shock resistance                                 |                         | S.R.           | ±10ppm max.                                                      | Three drops on a hard board from 75 cm or excitation test with 3000G x 0.3ms x 1/2 sine wave x 3 directions |

Metal may be exposed on the top of this product. This won't affect any quality, reliability or electrical spec.

#### External dimensions





### THE CRYSTALMASTER



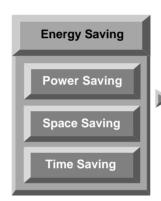
## ENERGY SAVING EPSON

EPSON offers effective savings to its customers through a wide range of electronic devices, such as semiconductors, liquid crystal display (LCD) modules, and crystal devices. These savings are achieved through a sophisticated melding of three different efficiency technologies.

Power saving technology provides low power consumption at low voltages.

Space saving technology provides further reductions in product size and weight through super-precise processing and high-density assembly technology.

Time saving technology shortens the time required for design and development on the customer side and shortens delivery times.



Our concept of Energy Saving technology conserves resources by blending the essence of these three efficiency technologies. The essence of these technologies is represented in each of the products that we provide to our customers.

In the industrial sector, leading priorities include measures to counter the greenhouse effect by reducing CO2,

measures to preserve the global environ-

ment, and the development of energyefficient products. Environmental
problems are of global concern, and
although the contribution of energysaving technology developed by
EPSON may appear insignificant,
we seek to contribute to the develop-

ment of energy-saving products by our

customers through the utilization of our electronic devices. EPSON is committed to the conservation of energy, both for the sake of people and of the planet on which we live.





Resource

Saving



SEIKO EPSON CORP. QUARTZ DEVICE DIVISION acquired ISO9001 and ISO14001 certification by B.V.Q.I. (Bureau Veritas Quality International).

ISO9001 in October, 1992. ISO14001 in November,1997.

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